

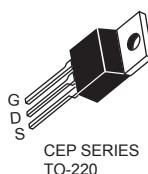
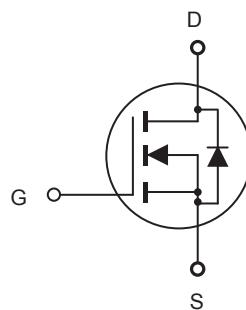


# CEP6060L/CEB6060L

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- 60V, 52.4A,  $R_{DS(ON)} = 21\text{m}\Omega$  @  $V_{GS} = 10\text{V}$ .  
 $R_{DS(ON)} = 25\text{m}\Omega$  @  $V_{GS} = 5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Lead free product is acquired.
- TO-220 & TO-263 package.

CEB SERIES  
TO-263(DD-PAK)CEP SERIES  
TO-220

### ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 16$	V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	52.4 37	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	210	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	$P_D$	120 0.8	W W/ $^\circ\text{C}$
Operating and Store Temperature Range	$T_J, T_{stg}$	-65 to 175	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.24	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$



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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$			25	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 16\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -16\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	1	1.4	2	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 26.2\text{A}$		17	21	$\text{m}\Omega$
		$V_{\text{GS}} = 5\text{V}, I_D = 26.2\text{A}$		20	25	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		1480		pF
Output Capacitance	$C_{\text{oss}}$			300		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			50		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = 30\text{V}, I_D = 48\text{A}, V_{\text{GS}} = 5\text{V}, R_{\text{GEN}} = 15\Omega$		15	19.5	ns
Turn-On Rise Time	$t_r$			4.5	5.9	ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			124	161.2	ns
Turn-On Fall Time	$t_f$			22	28.6	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 48\text{V}, I_D = 48\text{A}, V_{\text{GS}} = 10\text{V}$		45	58.5	nC
Gate-Source Charge	$Q_{\text{gs}}$			4.6		nC
Gate-Drain Charge	$Q_{\text{gd}}$			9		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				52.4	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 52.4\text{A}$		0.8	1.3	V

Notes : □

a.Repetitive Rating : Pulse width limited by maximum junction temperature.

b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .□

c.Guaranteed by design, not subject to production testing.□



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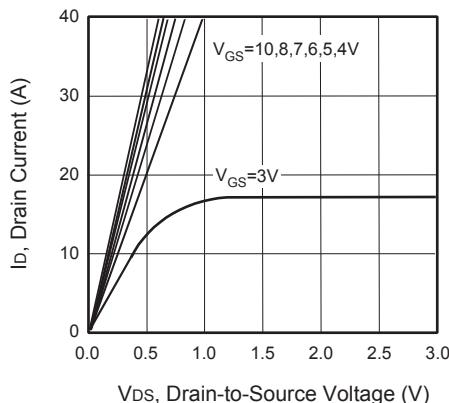


Figure 1. Output Characteristics

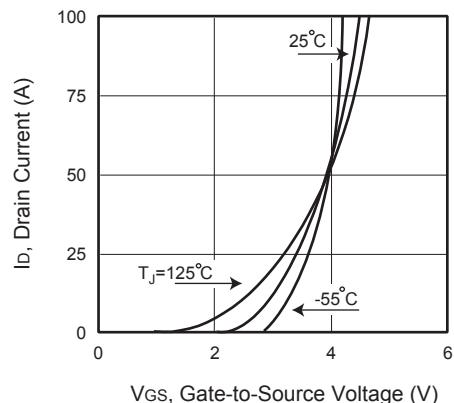


Figure 2. Transfer Characteristics

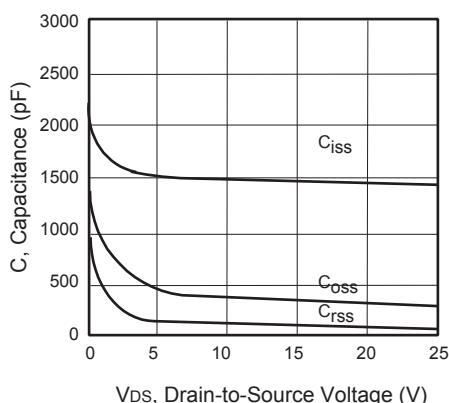


Figure 3. Capacitance

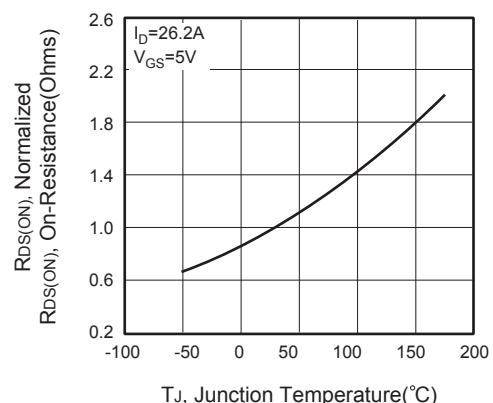


Figure 4. On-Resistance Variation with Temperature



Figure 5. Gate Threshold Variation with Temperature

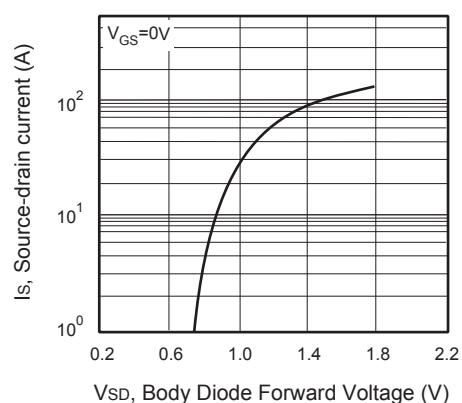
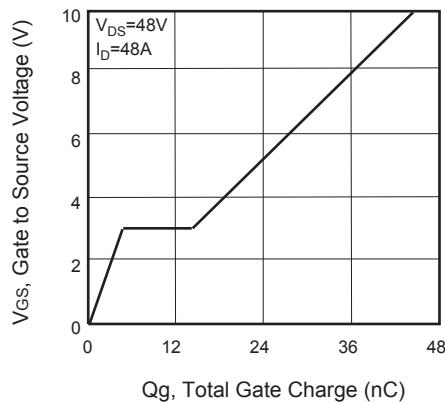


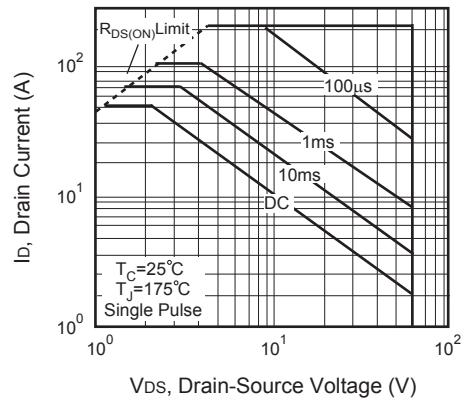
Figure 6. Body Diode Forward Voltage Variation with Source Current



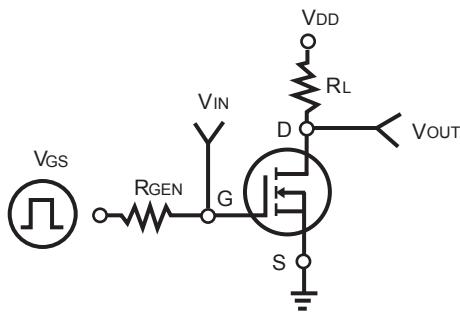
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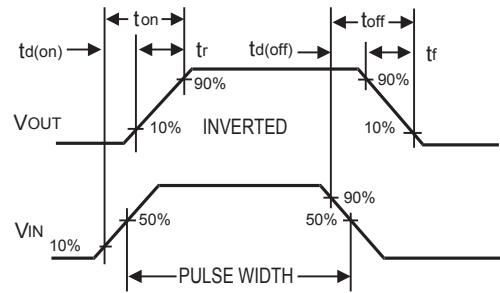
**Figure 7. Gate Charge**



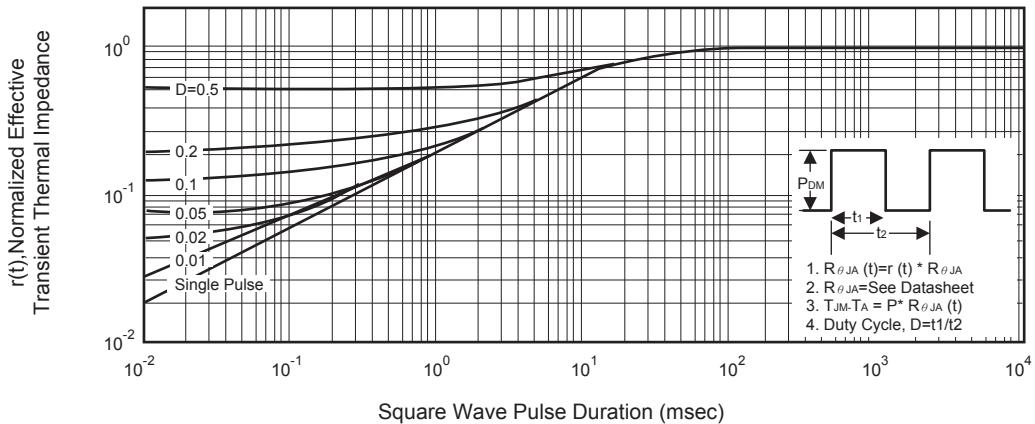
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Switching Test Circuit**



**Figure 10. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**